



# CMOS CAMERA MODULES

*your BEST camera module partner*

## KLT-USB1A-IMX258 V2.0

Sony IMX258 USB Interface Auto Focus 13MP Camera Module



Camera Module No.	KLT-USB1A-IMX258 V2.0	
Image Sensor	IMX258	Output Format: MJPG, YVY2, H.264
EFL	3.05 mm	30 FPS 1280 x 720 (HD 720P)
F.NO	2.2	30 FPS 1920 x 1080 (Full HD)
Pixel	4224 x 3192	20 FPS 4224 x 3192 (13MP)
View Angle	87.6°	Supporting OS
Lens Type	1/3.06 inch	Windows 7, 8.1, 10, Vista
Lens Dimensions	8.50 x 8.50 x 5.52 mm	Windows XP SP2 under UVC
Module Size	25.00 x 25.00 mm	Linux Kernel V2.6.2.1 or later
Module Type	Auto Focus	MAC OS 10.4 or later
IMT Lens Model	IMT-1A65H005-N	Operating Voltage: 5V +/- 5%
Interface	USB 2.0	Compliant with UVC Version 1.0
Mating USB Cable	KLT-USB6A-Cable	U-Green Style Extension Cable

### Mating USB Cable Part No. KLT-USB6A-Cable



Mating Connector On Main Board. Sold Separately.

[www.KaiLapTech.com](http://www.KaiLapTech.com) [sales@KaiLapTech.com](mailto:sales@KaiLapTech.com) Tel: (852) 6908 1256 Fax: (852) 3017 6778

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## [Product Brief]

Ver.1.0

# IMX258

Diagonal 5.867 mm (Type 1/3.06) 13Mega-Pixel CMOS Image Sensor with Square Pixel for Color Cameras

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### Description

IMX258 is a diagonal 5.867mm (Type 1/3.06) 13 Mega-pixel CMOS active pixel type stacked image sensor with a square pixel array. It adopts Exmor RSTM technology to achieve high speed image capturing by column parallel A/D converter circuits and high sensitivity and low noise image (comparing with conventional CMOS image sensor) through the backside illuminated imaging pixel structure. R, G, and B pigment primary color mosaic filter is employed. By introducing spatially multiplexed exposure technology, high dynamic range still pictures and movies are achievable. It

equips an electronic shutter with variable integration time. It operates with three power supply voltages: analog 2.7 V, digital 1.2 V and 1.8 V for input/output interface and achieves low power consumption.

In addition, this product is designed for use in cellular phone and tablet pc. When using this for another application, Sony does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and tablet pc. Consult your Sony sales representative if you have any questions.

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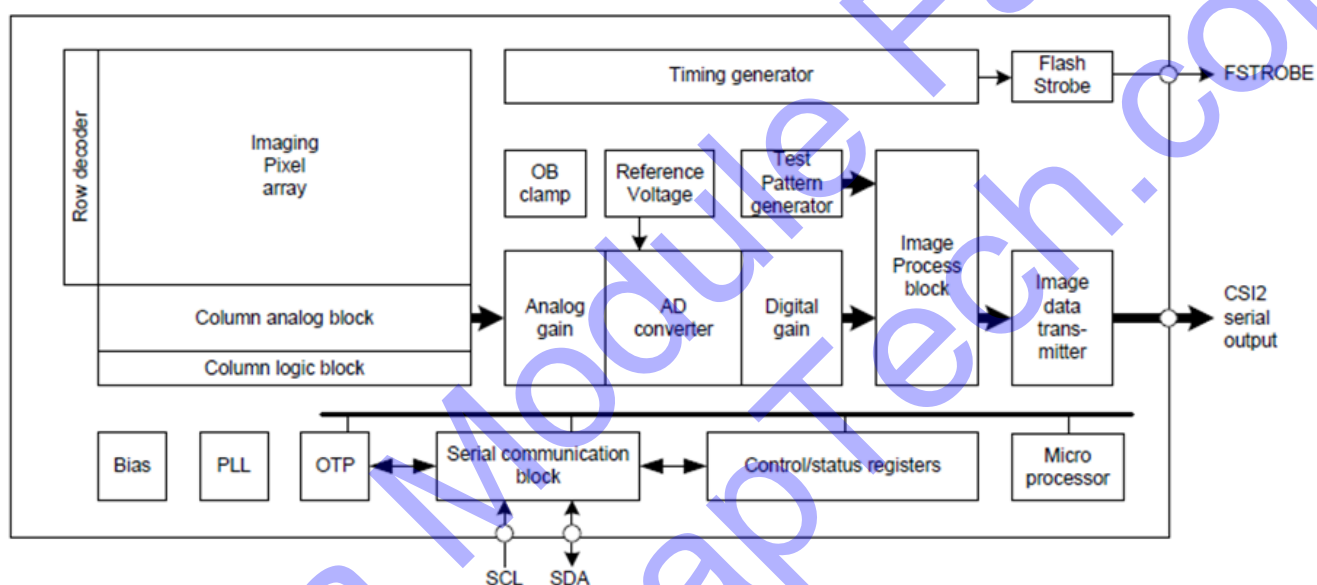
### Functions and Features

- ◆ Back-illuminated and stacked CMOS image sensor Exmor RSTM
- ◆ Phase Detection pixel data output for Phase Detection Auto Focus
- ◆ High Dynamic Range (HDR) mode with raw data output.
- ◆ High signal to noise ratio (SNR).
- ◆ Full resolution @30fps (Normal / HDR). 4K2K @30fps (Normal / HDR) 1080p @60fps (Normal )
- ◆ Output video format of RAW10/8.
- ◆ Pixel binning readout and V sub-sampling function.
- ◆ Independent flipping and mirroring.
- ◆ CSI-2 serial data output (MIPI 2lane/4lane, Max. 1.3Gbps/lane, D-PHY spec. ver. 1.1 compliant)
- ◆ 2-wire serial communication.
- ◆ Two PLLs for independent clock generation for pixel control and data output interface.
- ◆ Dynamic Defect Pixel Correction.
- ◆ Fast mode transition. (on the fly)
- ◆ Dual sensor synchronization operation.
- ◆ 4K bit of OTP ROM for users.
- ◆ Built-in temperature sensor.

## Device Structure

- ◆ CMOS image sensor
- ◆ Image size : Diagonal 5.867 mm (Type 1/3.06)
- ◆ Total number of pixels : 4224 (H) × 3192 (V) approx. 13.48 M pixels
- ◆ Number of effective pixels : 4224 (H) × 3144 (V) approx. 13.28 M pixels
- ◆ Number of active pixels : 4208 (H) × 3120 (V) approx. 13.13 M pixels
- ◆ Chip size : 5.990 mm (H) × 3.908 mm (V)
- ◆ Unit cell size : 1.12 μm (H) × 1.12 μm (V)
- ◆ Substrate material : Silicon

System block diagram



**Exmor RS**

\* Exmor RS is a trademark of Sony Corporation. The Exmor RS is a Sony's CMOS image sensor with high-resolution, high-performance and compact size by replacing a supporting substrate in Exmor R™ which changed fundamental structure of Exmor™ pixel adopted column parallel A/D converter to back-illuminated type, with layered chips formed signal processing circuits.